



LM111-LM211-LM311

Voltage comparator with strobe

Features

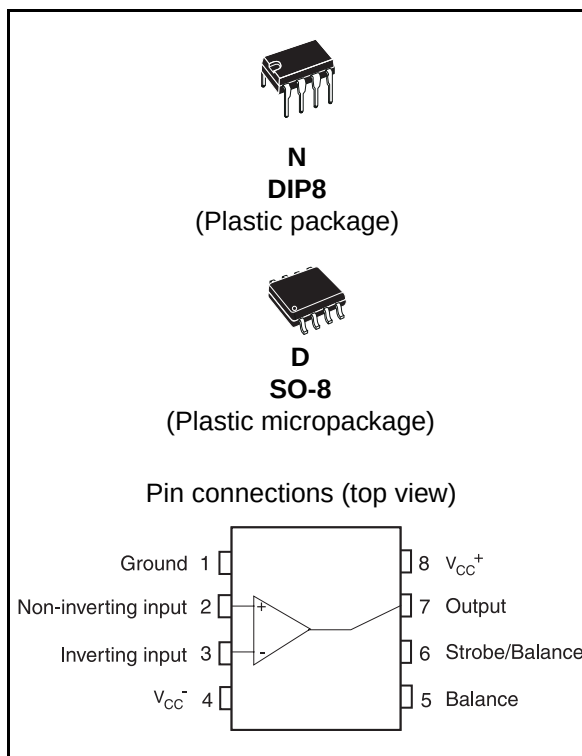
- Maximum input current: 150nA
- Maximum offset current: 20nA
- Differential input voltage range: $\pm 30V$
- Power consumption: 135mW at $\pm 15V$
- Supply voltage: +5V to $\pm 15V$
- Output current: 50mA

Description

The LM111, LM211, LM311 are voltage comparators that have low input currents.

They are also designed to operate over a wide range of supply voltages: from standard $\pm 15V$ operational amplifier supplies down to the single +5V supply used for IC logic.

Their output is compatible with RTL-DTL and TTL as well as MOS circuits and can switch voltages up to +50V at output currents as high as 50mA.



Order codes

Part number	Temperature range	Package	Packing	Marking
LM211N	-40°C, +105°C	DIP8	Tube	LM211N
LM211D/DT		SO-8	Tube or tape & reel	211
LM311N	0°C, +70°C	DIP8	Tube	LM311
LM311D/DT		SO-8	Tube or Tape & reel	311

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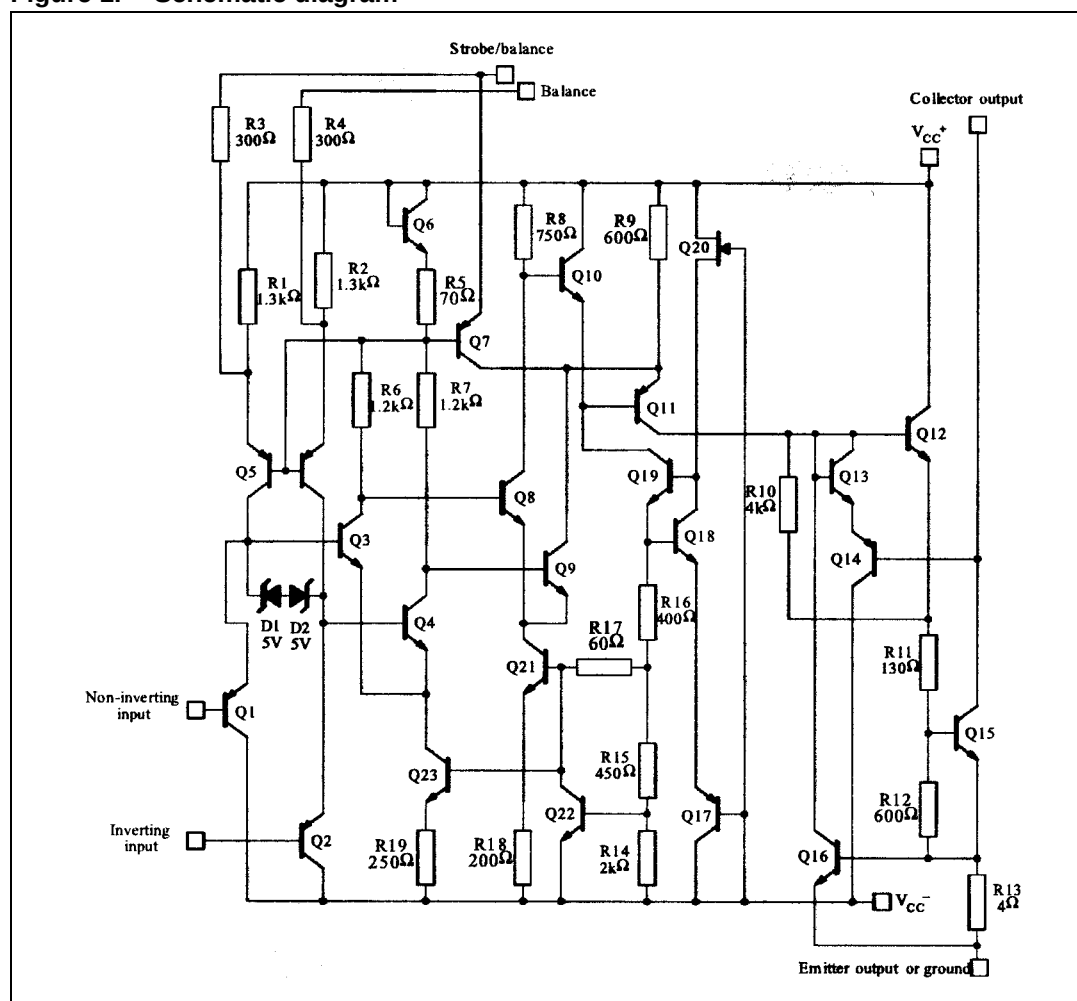
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1 Schematic diagram

Figure 1. Schematic diagram



2 Absolute maximum ratings & operating conditions

Table 1. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	36	V
V_{id}	Differential input voltage	± 30	V
V_i	Input voltage ⁽¹⁾	± 15	V
$V_{(1-4)}$	Ground to negative supply voltage	30	V
$V_{(7-4)}$	Output to negative supply voltage		
	LM111-LM211	50	V
	LM311	40	
	Output short-circuit duration	10	s
	Voltage at strobe pin	$V_{CC}^+ - 5$	V
P_d	Power dissipation ⁽²⁾		
	DIP8	1250	mW
	SO-8	710	
T_j	Junction temperature	+150	°C
T_{stg}	Storage temperature range	-65 to +150	°C

1. This rating applies for $\pm 15V$ supplies. The positive input voltage limit is 30V above the negative. The negative input voltage is equal to the negative supply voltage or 30V below the positive supply, whichever is less.
2. P_d is calculated with $T_{amb} = +25^\circ C$, $T_j = +150^\circ C$ and $R_{thja} = 100^\circ C/W$ for the DIP8 package, and $R_{thja} = 175^\circ C/W$ for the SO-8 package.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	5 to ± 15	V
T_{oper}	Operating free-air temperature range		
	LM111	-55 to +125	°C
	LM211	-40 to +105	
	LM311	0 to +70	

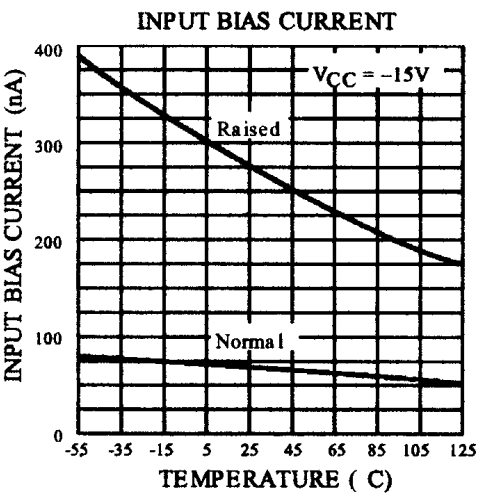
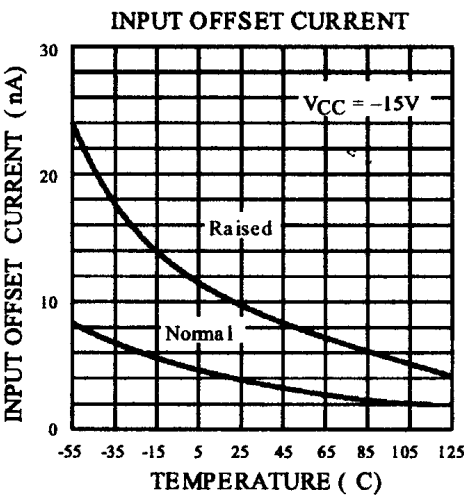
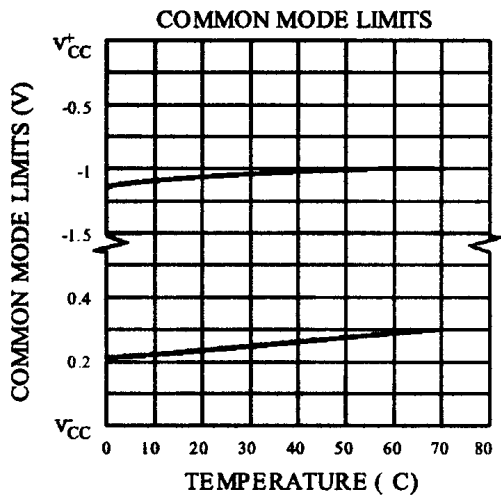
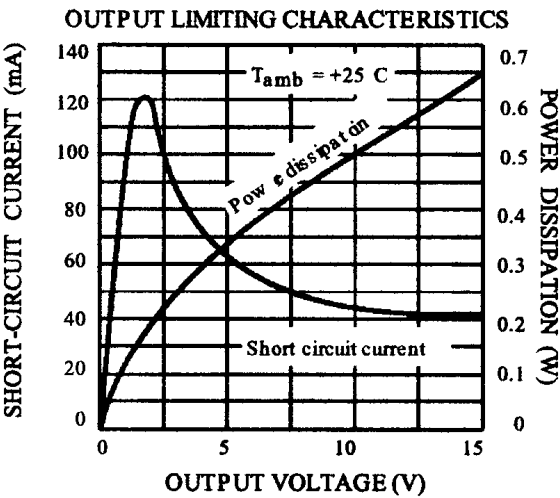
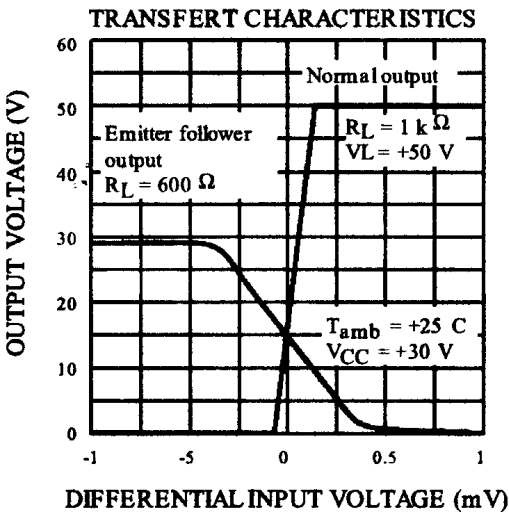
3 Electrical characteristics

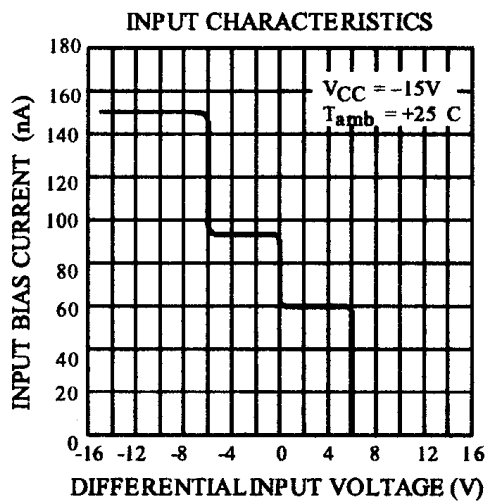
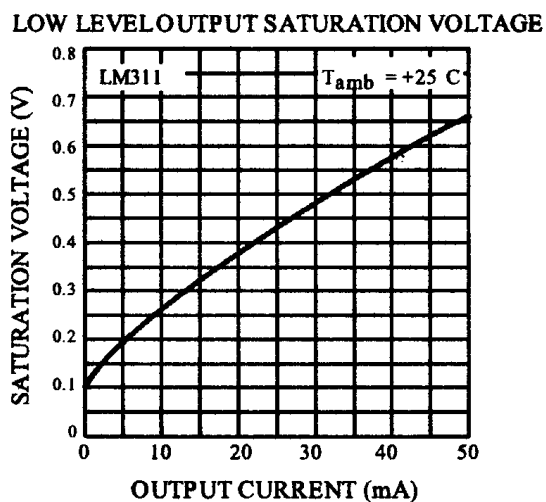
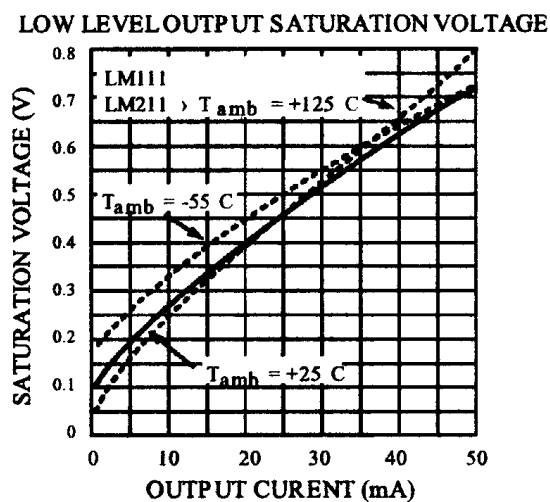
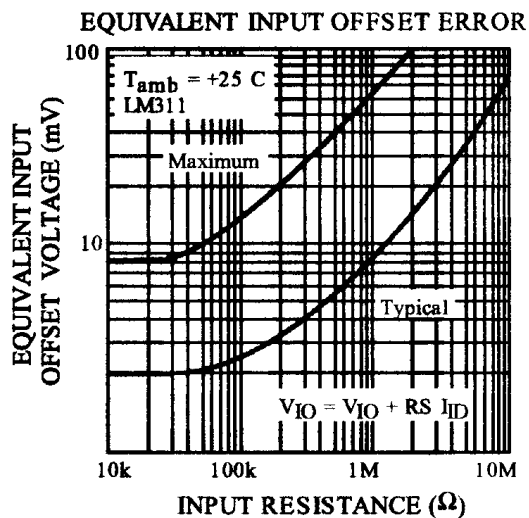
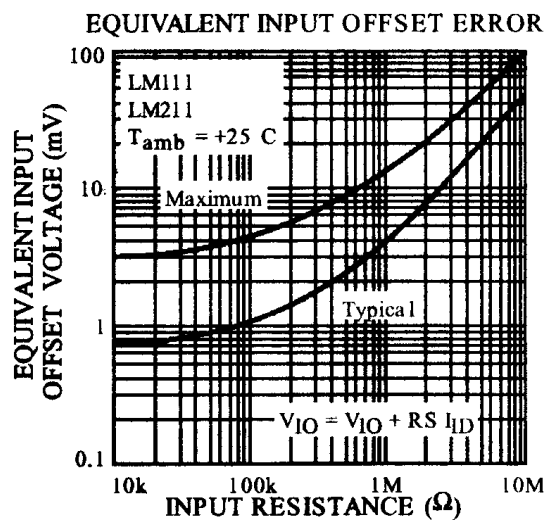
Table 3. $V_{CC}^+ = \pm 15V$, $T_{amb} = +25^\circ C$ (unless otherwise specified)

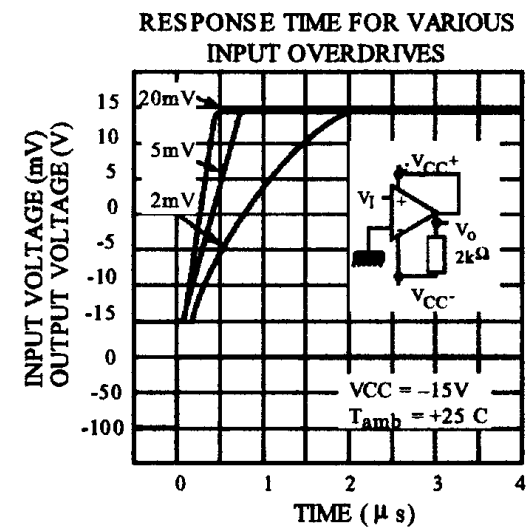
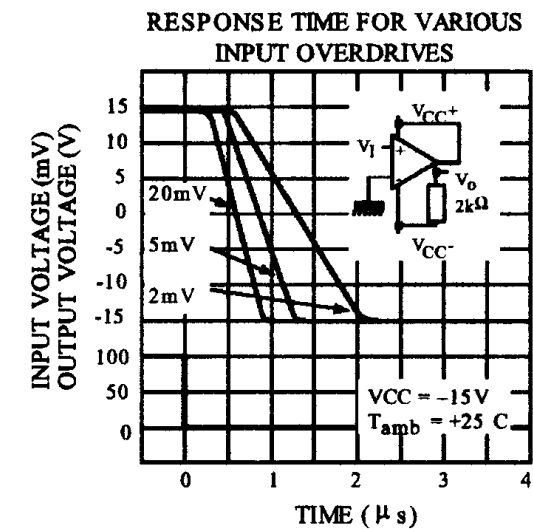
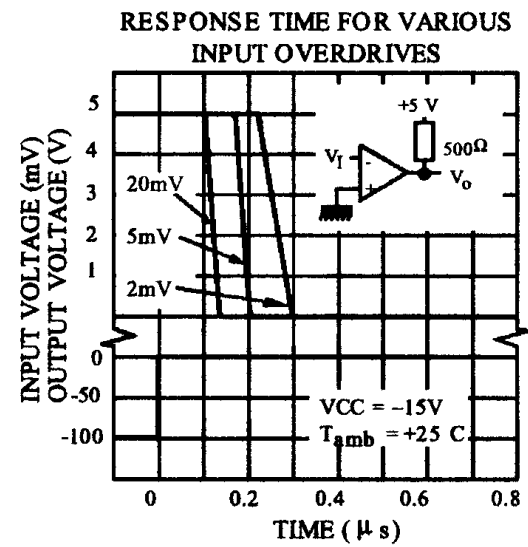
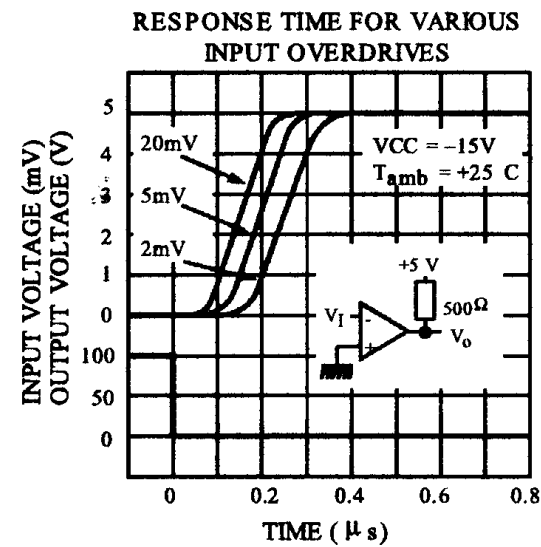
Symbol	Parameter	Conditions	LM111 - LM211			LM311			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input offset voltage ⁽¹⁾	$R_S \leq 50k\Omega$ $T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		0.7	3 4		2	7.5 10	mV
I_{io}	Input offset current ⁽¹⁾	$T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		4	10 20		6	50 70	nA
I_{ib}	Input bias current ⁽¹⁾	$T_{amb} = +25^\circ C$ $T_{min} \leq T_{amb} \leq T_{max}$		60	100 150		100	250 300	nA
A_{vd}	Large signal voltage gain		40	200		40	200		V/mV
I_{CC}^+ I_{CC}^-	Supply currents	Positive Negative		5.1 4.1	6 5		5.1 4.1	7.5 5	mA
V_{icm}	Input common mode voltage range	$T_{min} \leq T_{amb} \leq T_{max}$	-14.5	+13.8 -14.7	+13	-14.5	+13.8 -14.7	+13	V
V_{OL}	Low level output voltage	$T_{amb} = +25^\circ C$, $I_O = 50mA$, $V_i \leq -5mV$		0.75	1.5				V
		$T_{amb} = +25^\circ C$, $I_O = 50mA$, $V_i \leq -10mV$					0.75	1.5	
		$T_{min} \leq T_{amb} \leq T_{max}$ $V_{CC}^+ \geq +4.5V$, $V_{CC}^- = 0$ $I_O = 8mA$, $V_i \leq -6m$		0.23	0.4				
		$T_{min} \leq T_{amb} \leq T_{max}$ $V_{CC}^+ \geq +4.5V$, $V_{CC}^- = 0$ $I_O = 8mA$, $V_i \leq -10mV$					0.23	0.4	
I_{OH}	High level output current	$T_{amb} = +25^\circ C$ $V_i \geq +5mV$, $V_O = +35V$		0.2	10				nA
		$T_{amb} = +25^\circ C$ $V_i \geq +10mV$, $V_O = +35V$					0.2	50	nA
		$T_{min} \leq T_{amb} \leq T_{max}$ $V_i \geq +5mV$, $V_O = +35V$		0.1	0.5				μA
I_{strobe}	Strobe current			3			3		mA
t_{re}	Response time ⁽²⁾			200			200		ns

1. The offset voltage, offset current and bias current specifications apply for any supply voltage from a single +5V supply up to $\pm 15V$ supplies. The offset voltages and offset currents given are the maximum values required to drive the output down to +1V or up to +14V with a 1mA load current. Thus, these parameters define an error band and take into account the worst-case of voltage gain and input impedance.

2. The response time specified is for a 100mV input step with 5mV overdrive.



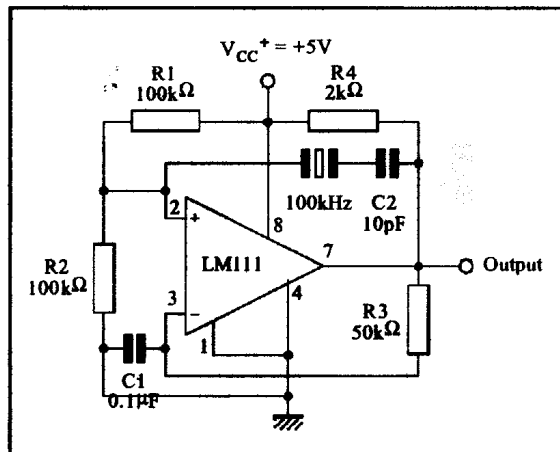




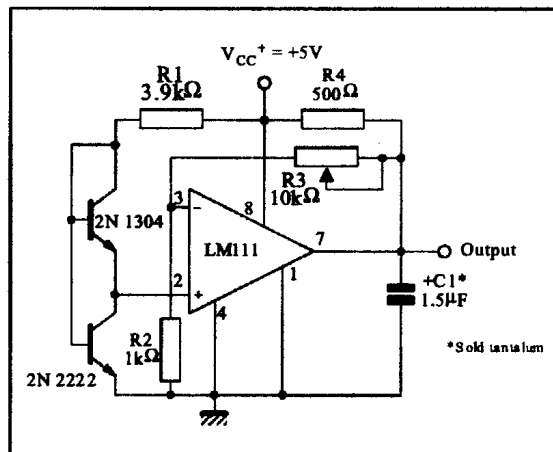
4 Typical application schematics

TYPICAL APPLICATIONS

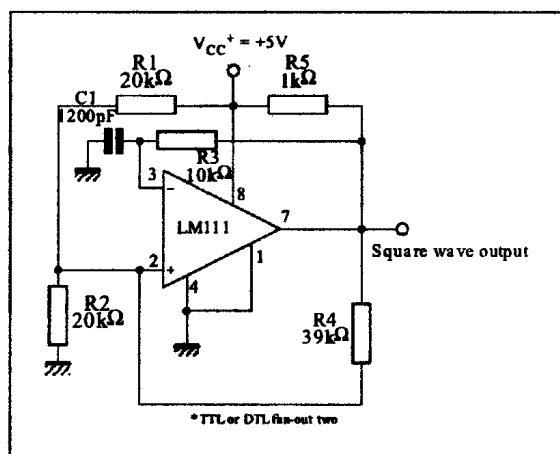
CRYSTAL OSCILLATOR



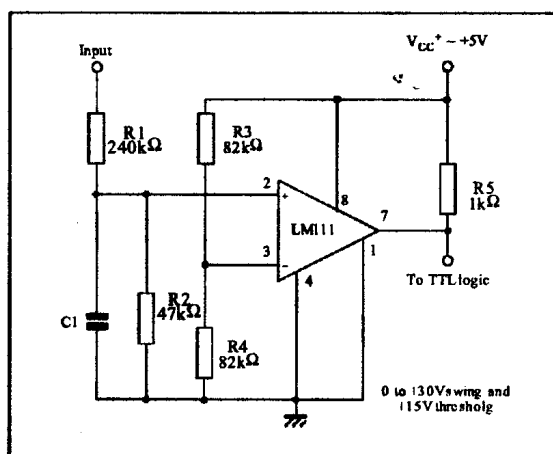
LOW VOLTAGE ADJUSTABLE REFERENCE SUPPLY



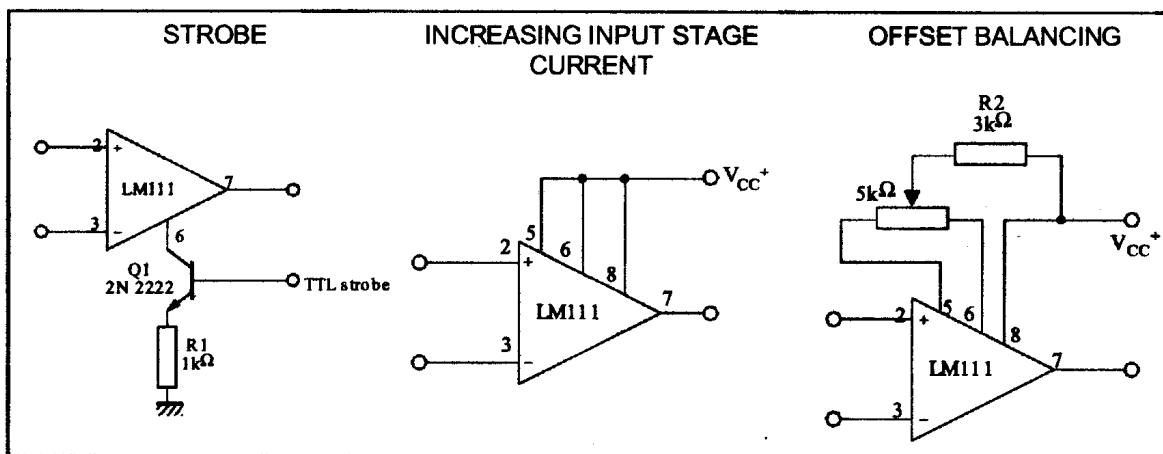
100KHz FREE RUNNING MULTIVIBRATOR



TTL INTERFACE WITH HIGH LEVEL LOGIC



AUXILIARY CIRCUITS



5 Package mechanical data

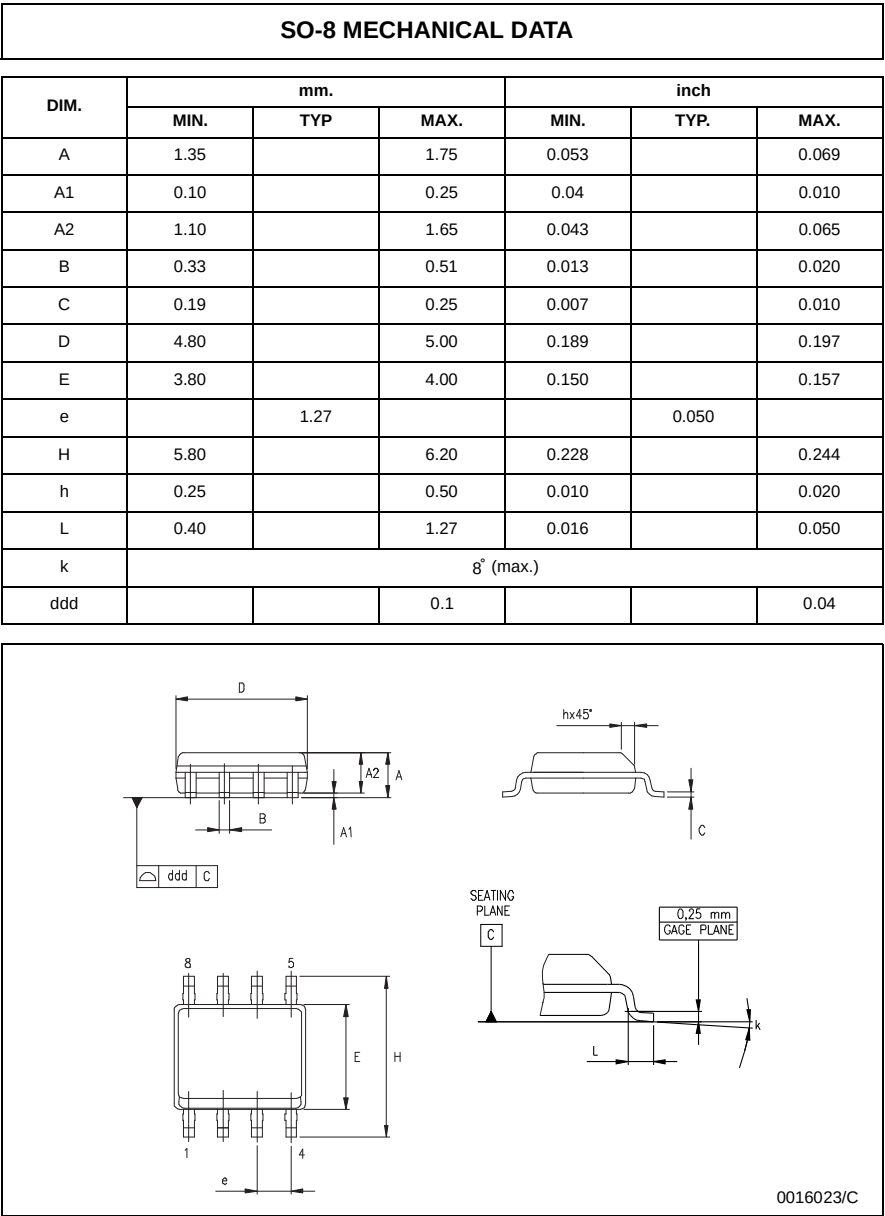
In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

5.1 DIP8 package

Plastic DIP-8 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063

The diagram illustrates the mechanical specifications of a Plastic DIP-8 package through three views: top, side, and bottom. The top view shows the package body with pins extending from all four sides. Key dimensions labeled include A (height of the package body), a1 (pin thickness), B and B1 (pin spacing), b and b1 (pin width), D (total width), e (pin pitch), e3 (width between side pins), e4 (width between top pins), F (maximum pin length), I (pin length), L (package length), and Z (lead thickness). The side view shows the profile of the package with dimensions E (body height) and b1 (pin height). The bottom view shows the package footprint with pins and is labeled with pin numbers 1, 4, 5, and 8. The identifier P001F is located in the bottom right corner of the diagram area.

5.2 SO-8 package



6 Revision history

Date	Revision	Changes
1-Jun-02	1	Initial release.
2-Jan-06	2	Table 3. on page 5 updated. Formatting changes throughout.
1-Mar-06	3	Pin connections updated on page 1.
26-Sep-06	4	Corrected description under title on cover page.

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